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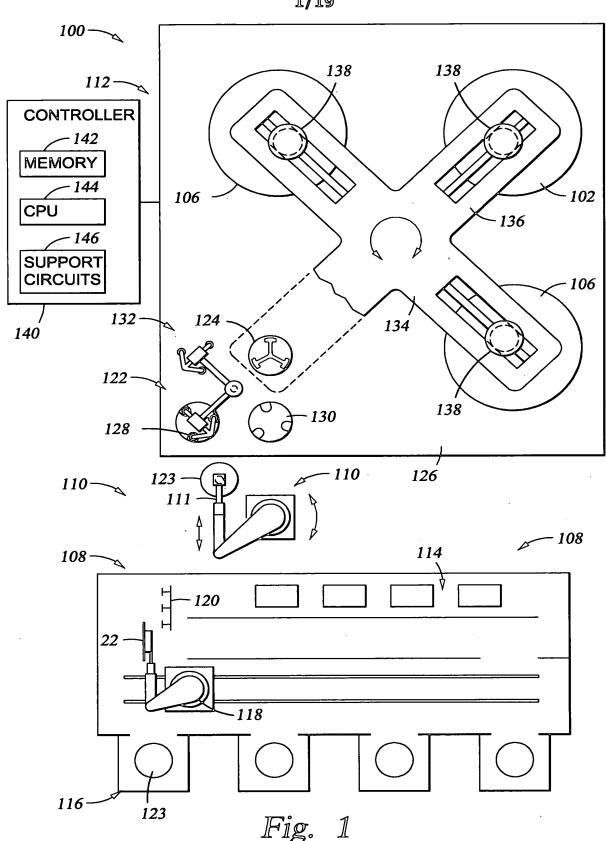
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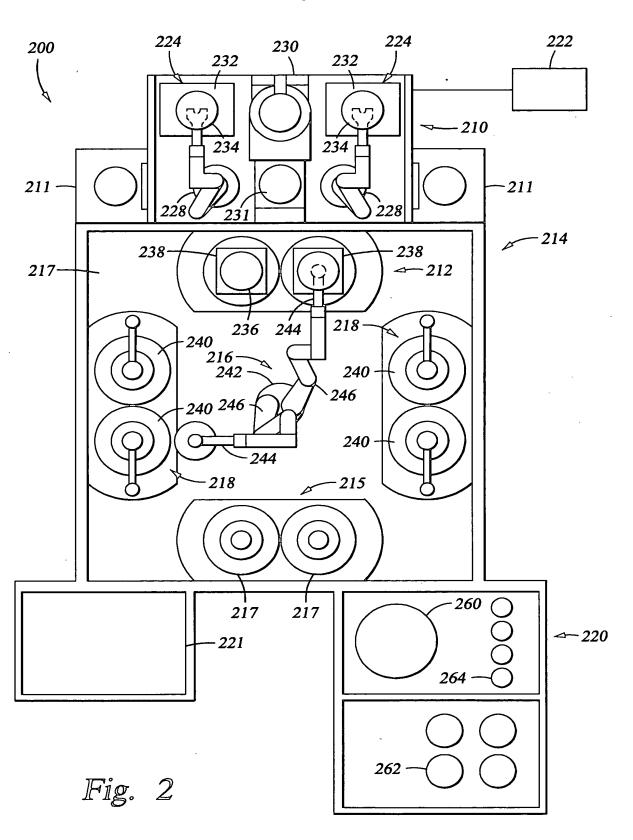
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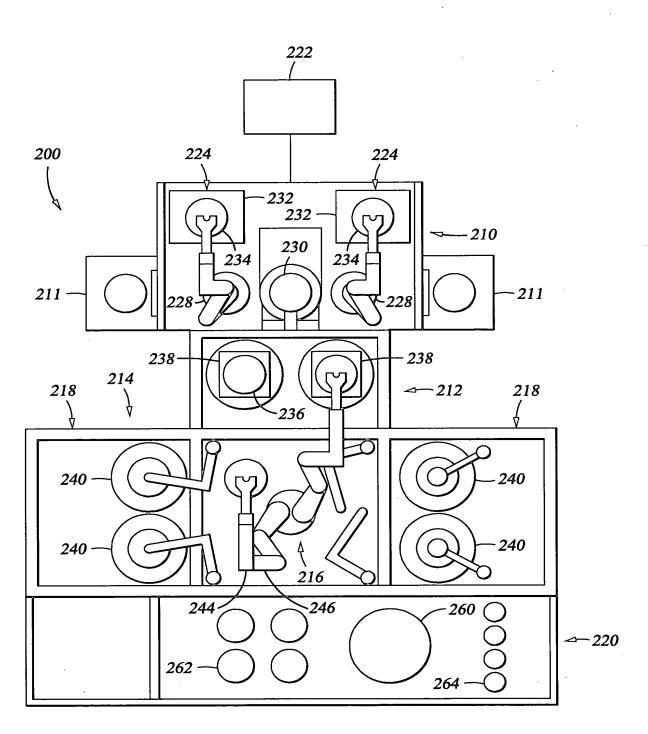


Fig. 3

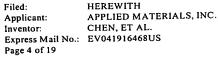
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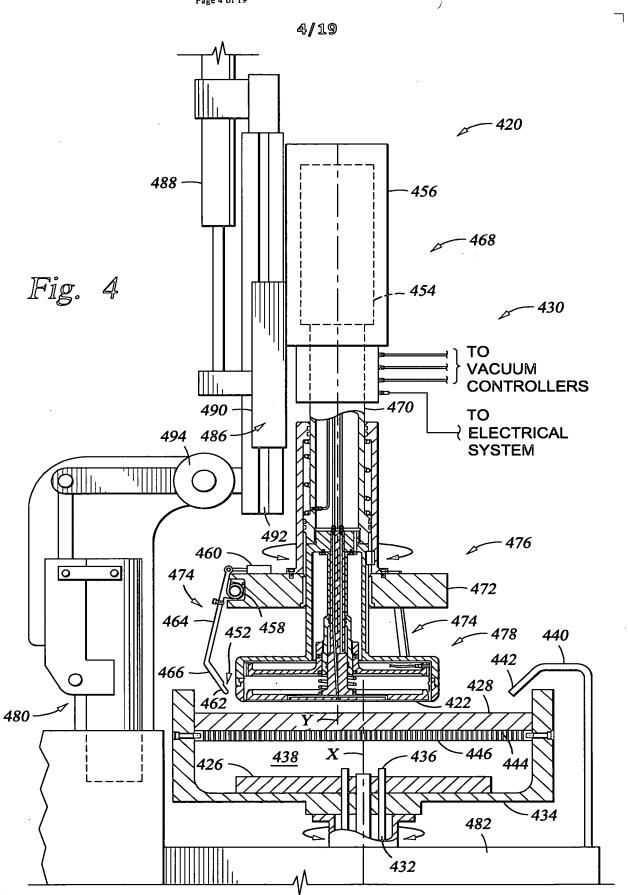
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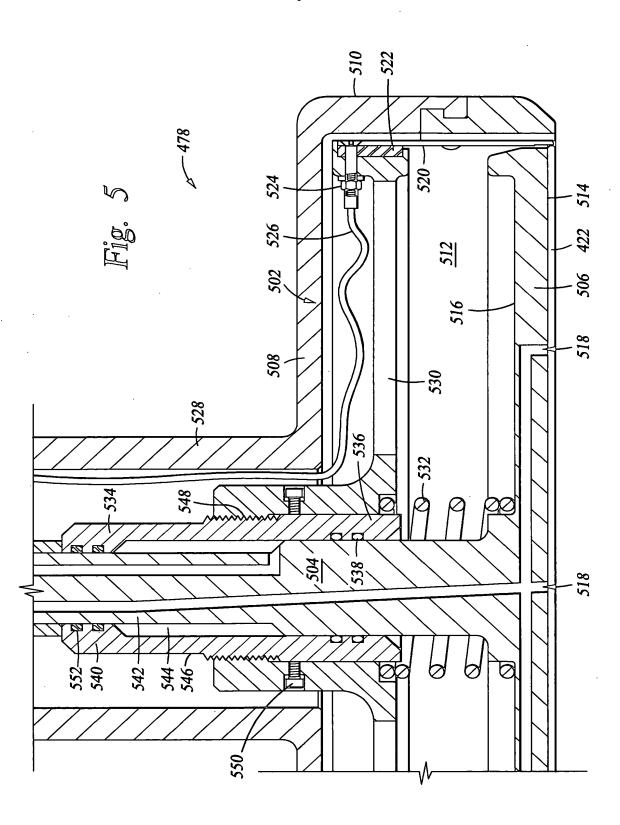
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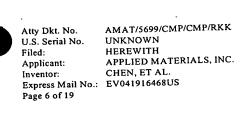




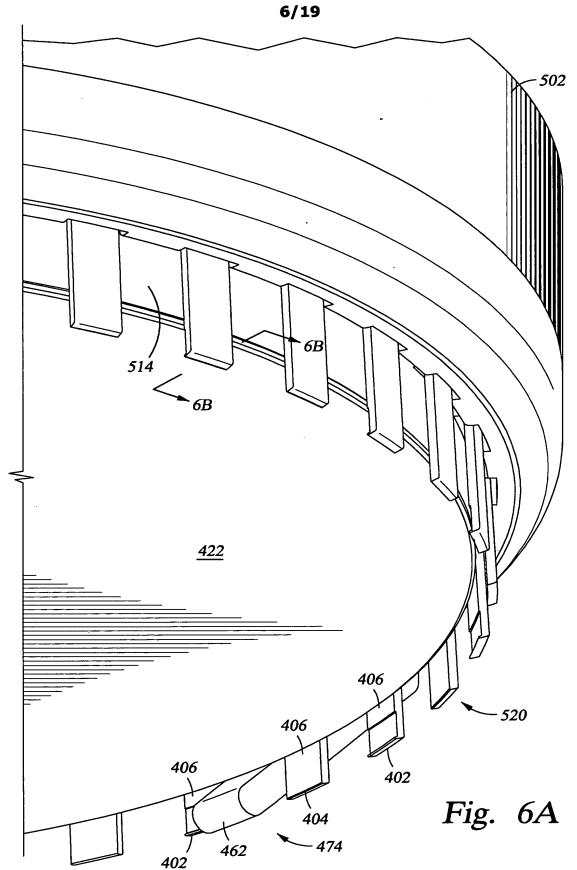
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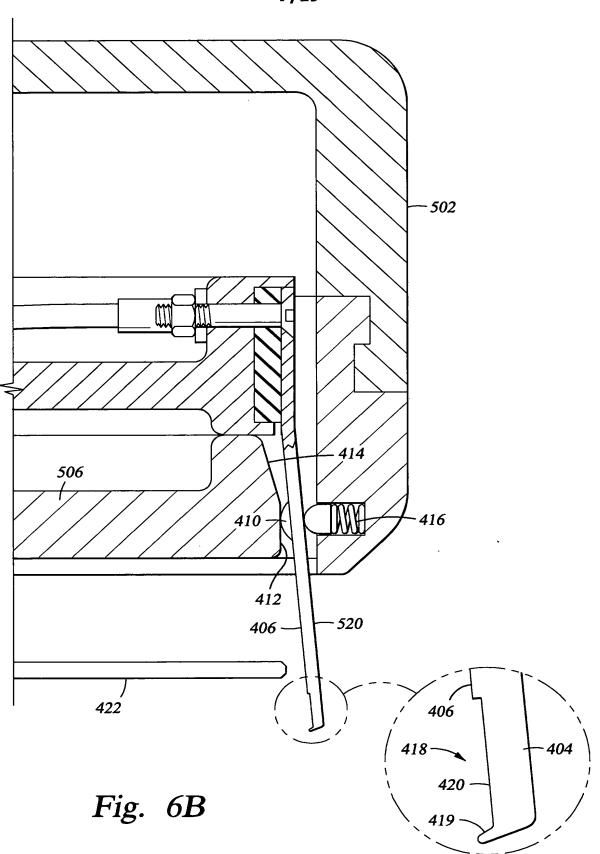


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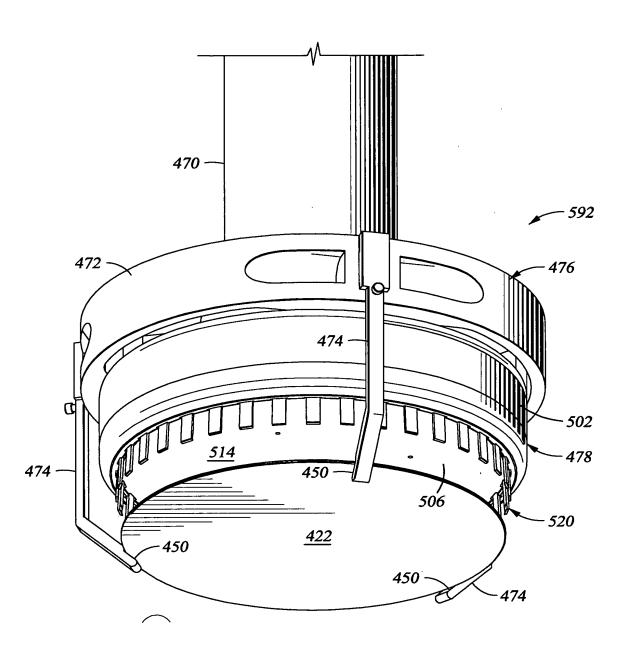


Fig. 7A



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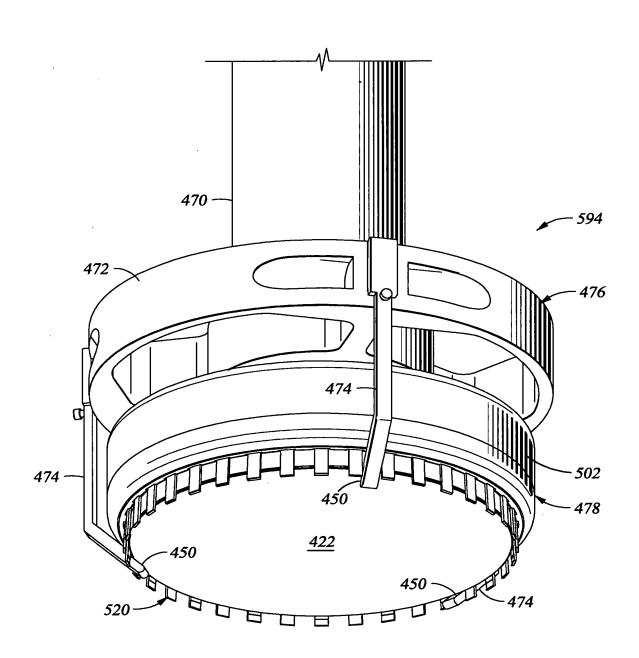
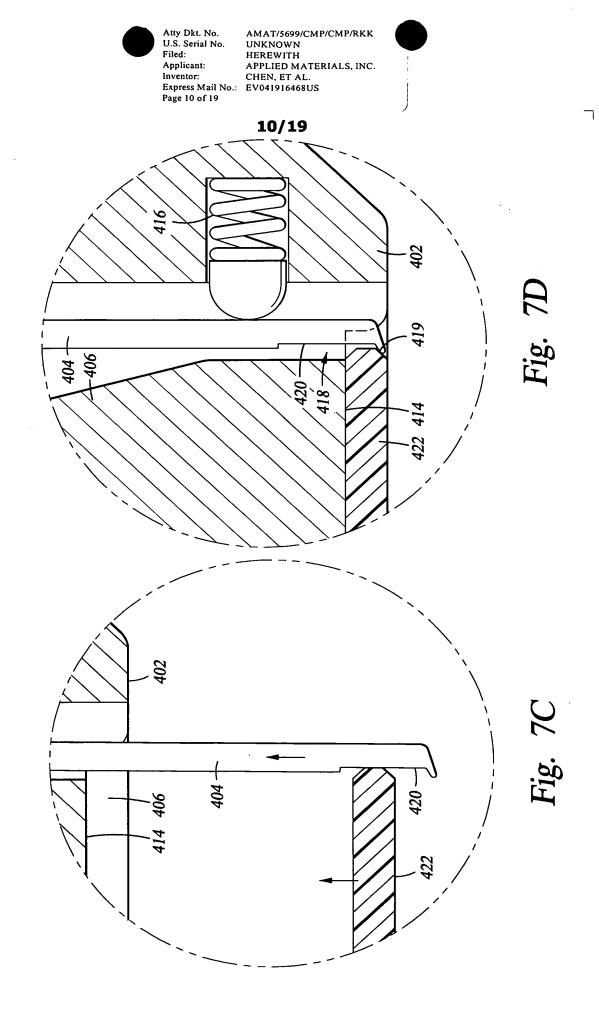
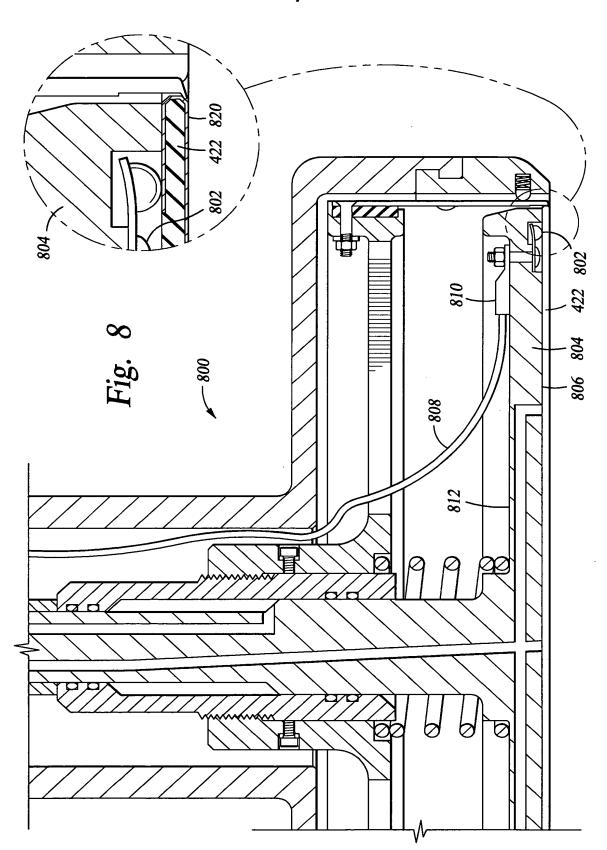


Fig. 7B

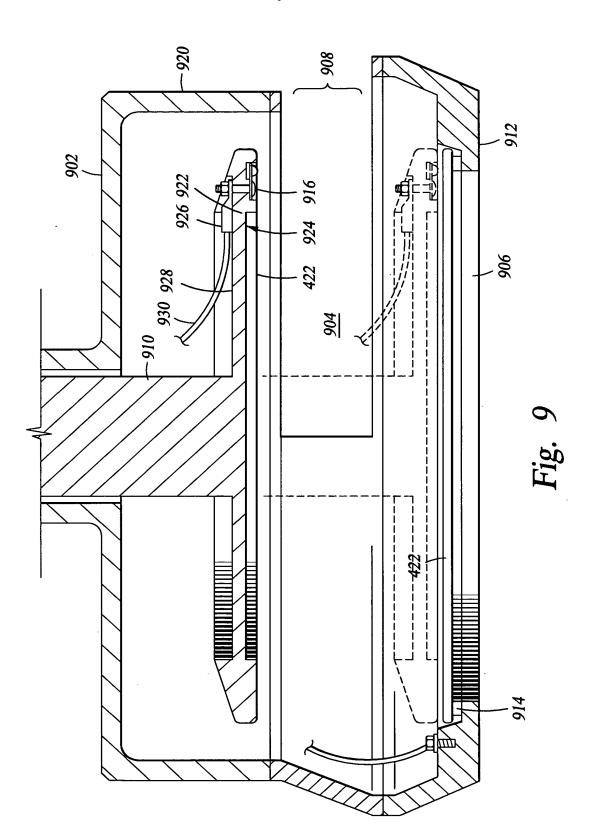


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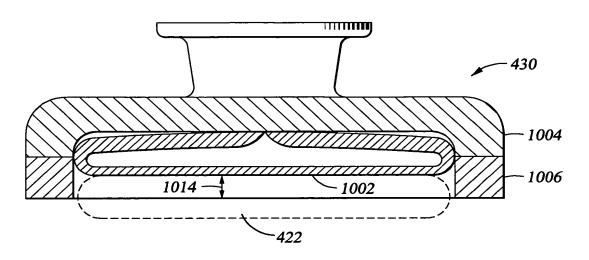


Fig. 10A

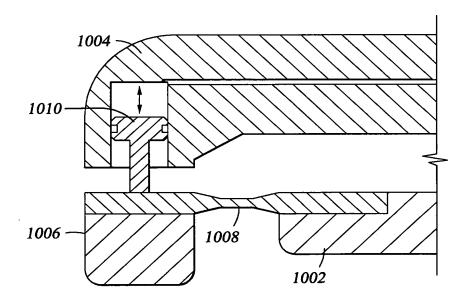


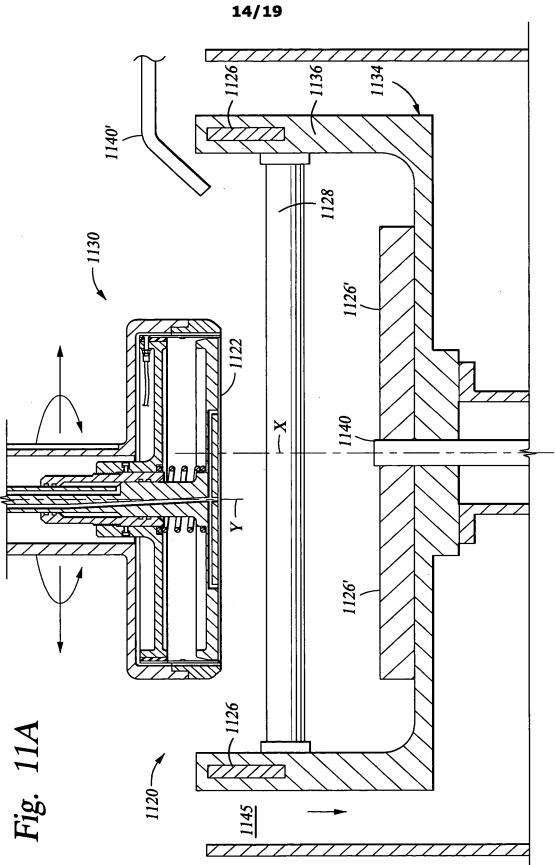
Fig. 10B

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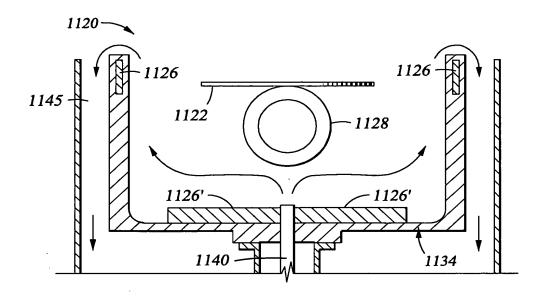


Fig. 11B

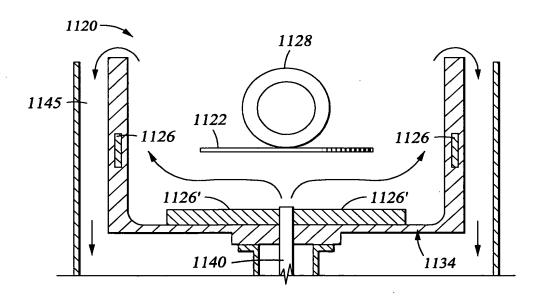


Fig. 11C

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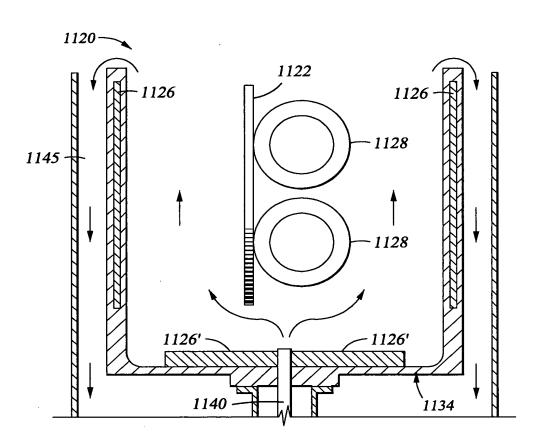


Fig. 11D



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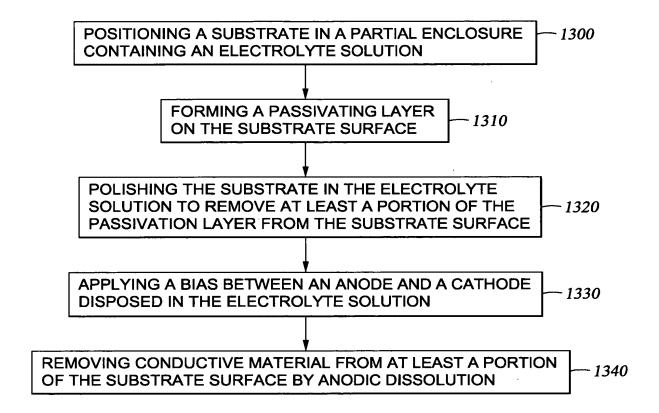


Fig. 12



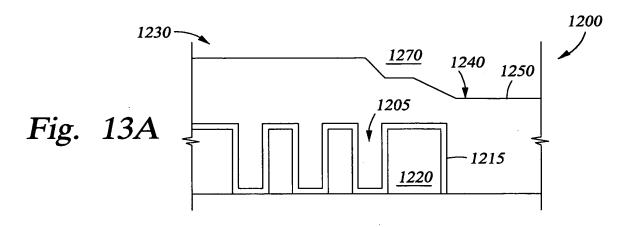
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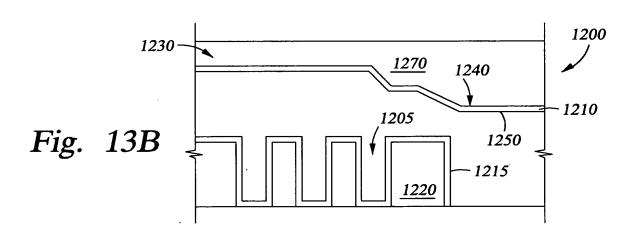
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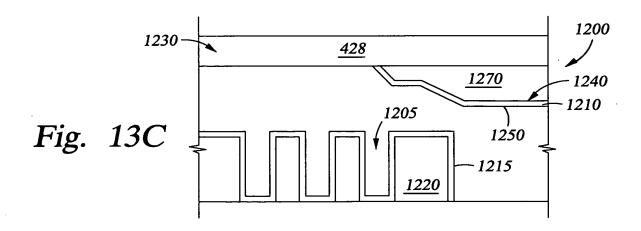


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